

Nineteen Output Differential Buffer for PCIe Gen3

9DB1933

Recommended Application

19 output PCIe Gen3 zero-delay/fanout buffer

General Description

The 9DB1933 zero-delay buffer supports PCIe Gen3 requirements, while being backwards compatible to PCIe Gen2 and Gen1. The 9DB1933 is driven by a differential SRC output pair from an IDT 932S421, 932SQ420, or equivalent, main clock generator. It attenuates jitter on the input clock and has a selectable PLL bandwidth to maximize performance in systems with or without Spread-Spectrum clocking.

Output Features

- 19 - 0.7V current mode differential HCSL output pairs

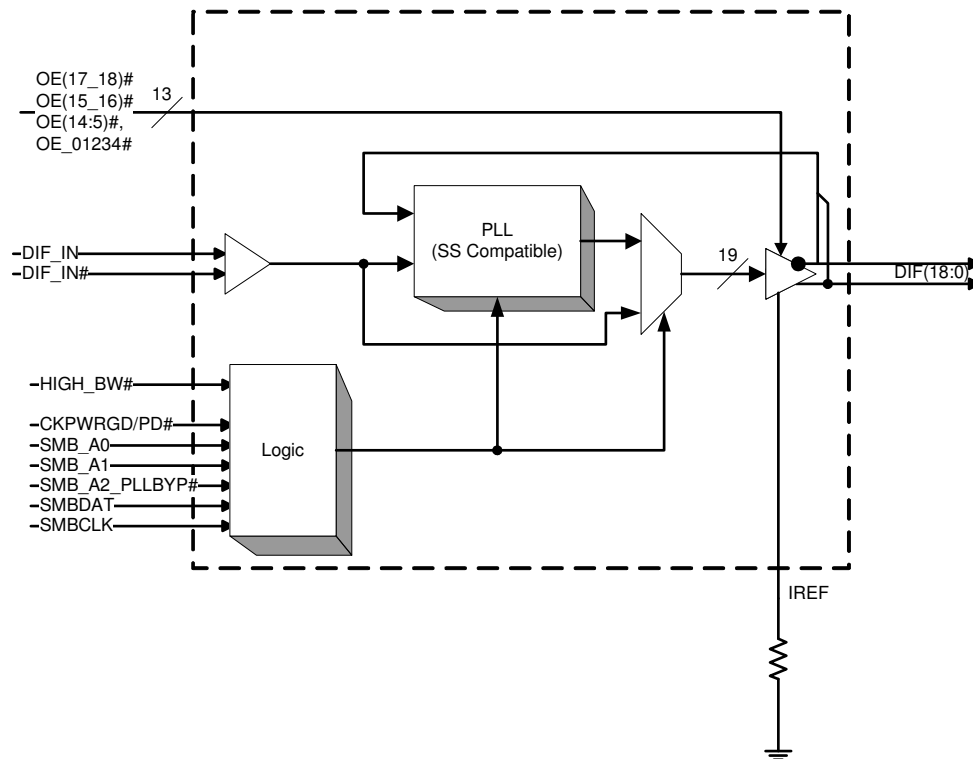
Features/Benefits

- 8 Selectable SMBus Addresses/Multiple devices can share the same SMBus Segment
- 11 dedicated and 3 group OE# pins/Hardware control of the outputs
- PLL or bypass mode/PLL can de-jitter incoming clock
- Selectable PLL bandwidth/minimizes jitter peaking in downstream PLL's
- Spread Spectrum Compatible/tracks spreading input clock for low EMI
- SMBus Interface/unused outputs can be disabled
- Supports undriven differential outputs in Power Down mode for power management

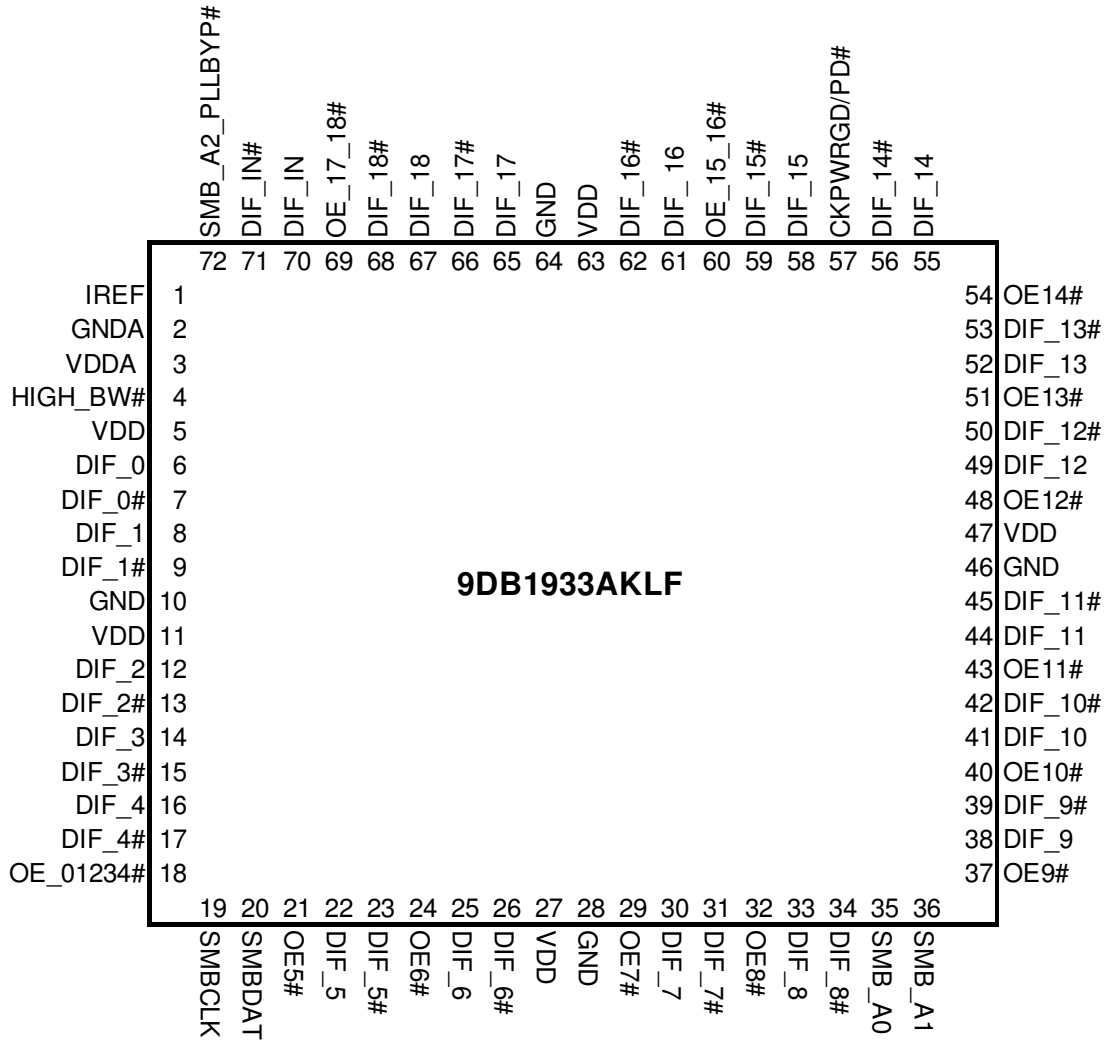
Key Specifications

- Cycle-to-cycle jitter < 50ps
- Output-to-output skew < 150 ps
- PCIe Gen3 phase jitter < 1.0ps RMS

Functional Block Diagram



Pin Configuration



Power Down Functionality

| INPUTS | | OUTPUTS | PLL State |
|-----------------|--------------------|----------|-----------|
| CKPWRGD/ PD# | DIF_IN/ DIF_IN# | DIF/DIF# | |
| 1 | Running | Running | ON |
| 0 | X | Hi-Z | OFF |

Power Groups

| Pin Number | | Description |
|---------------|-------------|-------------|
| VDD | GND | |
| 3 | 2 | PLL, Analog |
| 5,11,27,47,63 | 10,28,46,64 | DIF clocks |

Pin Description

| PIN # | PIN NAME | PIN TYPE | DESCRIPTION |
|-------|-----------|----------|---|
| 1 | IREF | OUT | This pin establishes the reference current for the differential current-mode output pairs. This pin requires a fixed precision resistor tied to ground in order to establish the appropriate current. 475 ohms is the standard value. |
| 2 | GNDA | PWR | Ground pin for the PLL core. |
| 3 | VDDA | PWR | 3.3V power for the PLL core. |
| 4 | HIGH_BW# | IN | 3.3V input for selecting PLL Band Width 0 = High, 1= Low |
| 5 | VDD | PWR | Power supply, nominal 3.3V |
| 6 | DIF_0 | OUT | 0.7V differential true clock output |
| 7 | DIF_0# | OUT | 0.7V differential Complementary clock output |
| 8 | DIF_1 | OUT | 0.7V differential true clock output |
| 9 | DIF_1# | OUT | 0.7V differential Complementary clock output |
| 10 | GND | PWR | Ground pin. |
| 11 | VDD | PWR | Power supply, nominal 3.3V |
| 12 | DIF_2 | OUT | 0.7V differential true clock output |
| 13 | DIF_2# | OUT | 0.7V differential Complementary clock output |
| 14 | DIF_3 | OUT | 0.7V differential true clock output |
| 15 | DIF_3# | OUT | 0.7V differential Complementary clock output |
| 16 | DIF_4 | OUT | 0.7V differential true clock output |
| 17 | DIF_4# | OUT | 0.7V differential Complementary clock output |
| 18 | OE_01234# | IN | Active low input for enabling DIF pairs 0, 1, 2, 3 and 4. 1 =disable outputs, 0 = enable outputs |
| 19 | SMBCLK | IN | Clock pin of SMBUS circuitry, 5V tolerant |
| 20 | SMBDAT | I/O | Data pin of SMBUS circuitry, 5V tolerant |
| 21 | OE5# | IN | Active low input for enabling DIF pair 5. 1 =disable outputs, 0 = enable outputs |
| 22 | DIF_5 | OUT | 0.7V differential true clock output |
| 23 | DIF_5# | OUT | 0.7V differential Complementary clock output |
| 24 | OE6# | IN | Active low input for enabling DIF pair 6. 1 =disable outputs, 0 = enable outputs |
| 25 | DIF_6 | OUT | 0.7V differential true clock output |
| 26 | DIF_6# | OUT | 0.7V differential Complementary clock output |
| 27 | VDD | PWR | Power supply, nominal 3.3V |
| 28 | GND | PWR | Ground pin. |
| 29 | OE7# | IN | Active low input for enabling DIF pair 7. 1 =disable outputs, 0 = enable outputs |
| 30 | DIF_7 | OUT | 0.7V differential true clock output |
| 31 | DIF_7# | OUT | 0.7V differential Complementary clock output |
| 32 | OE8# | IN | Active low input for enabling DIF pair 8. 1 =disable outputs, 0 = enable outputs |
| 33 | DIF_8 | OUT | 0.7V differential true clock output |
| 34 | DIF_8# | OUT | 0.7V differential Complementary clock output |
| 35 | SMB_A0 | IN | SMBus address bit 0 (LSB) |
| 36 | SMB_A1 | IN | SMBus address bit 1 |

Pin Description (cont.)

| PIN # | PIN NAME | PIN TYPE | DESCRIPTION |
|-------|----------------|----------|---|
| 37 | OE9# | IN | Active low input for enabling DIF pair 9. 1 =disable outputs, 0 = enable outputs |
| 38 | DIF_9 | OUT | 0.7V differential true clock output |
| 39 | DIF_9# | OUT | 0.7V differential Complementary clock output |
| 40 | OE10# | IN | Active low input for enabling DIF pair 10. 1 =disable outputs, 0 = enable outputs |
| 41 | DIF_10 | OUT | 0.7V differential true clock output |
| 42 | DIF_10# | OUT | 0.7V differential Complementary clock output |
| 43 | OE11# | IN | Active low input for enabling DIF pair 11. 1 =disable outputs, 0 = enable outputs |
| 44 | DIF_11 | OUT | 0.7V differential true clock output |
| 45 | DIF_11# | OUT | 0.7V differential Complementary clock output |
| 46 | GND | PWR | Ground pin. |
| 47 | VDD | PWR | Power supply, nominal 3.3V |
| 48 | OE12# | IN | Active low input for enabling DIF pair 12. 1 =disable outputs, 0 = enable outputs |
| 49 | DIF_12 | OUT | 0.7V differential true clock output |
| 50 | DIF_12# | OUT | 0.7V differential Complementary clock output |
| 51 | OE13# | IN | Active low input for enabling DIF pair 13. 1 =disable outputs, 0 = enable outputs |
| 52 | DIF_13 | OUT | 0.7V differential true clock output |
| 53 | DIF_13# | OUT | 0.7V differential Complementary clock output |
| 54 | OE14# | IN | Active low input for enabling DIF pair 14. 1 =disable outputs, 0 = enable outputs |
| 55 | DIF_14 | OUT | 0.7V differential true clock output |
| 56 | DIF_14# | OUT | 0.7V differential Complementary clock output |
| 57 | CKPWRGD/PD# | IN | A rising edge samples latched inputs and release Power Down Mode, a low puts the part into power down mode and tristates all outputs. |
| 58 | DIF_15 | OUT | 0.7V differential true clock output |
| 59 | DIF_15# | OUT | 0.7V differential Complementary clock output |
| 60 | OE_15_16# | IN | Active low input for enabling DIF pair 15 and 16. 1 = tri-state outputs, 0 = enable outputs |
| 61 | DIF_16 | OUT | 0.7V differential true clock output |
| 62 | DIF_16# | OUT | 0.7V differential Complementary clock output |
| 63 | VDD | PWR | Power supply, nominal 3.3V |
| 64 | GND | PWR | Ground pin. |
| 65 | DIF_17 | OUT | 0.7V differential true clock output |
| 66 | DIF_17# | OUT | 0.7V differential Complementary clock output |
| 67 | DIF_18 | OUT | 0.7V differential true clock output |
| 68 | DIF_18# | OUT | 0.7V differential Complementary clock output |
| 69 | OE_17_18# | IN | Active low input for enabling DIF pair 17, 18. 1 = tri-state outputs, 0 = enable outputs |
| 70 | DIF_IN | IN | 0.7 V Differential TRUE input |
| 71 | DIF_IN# | IN | 0.7 V Differential Complementary Input |
| 72 | SMB_A2_PLLBYP# | IN | SMBus address bit 2. When Low, the part operates as a fanout buffer with the PLL bypassed. When High, the part operates as a zero-delay buffer (ZDB) with the PLL operating. 0 = fanout mode (PLL bypassed), 1 = ZDB mode (PLL used) |

Electrical Characteristics - Absolute Maximum Ratings

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|---------------------------|--------------------|----------------------------|---------|-----|-----------------------|-------|-------|
| 3.3V Core Supply Voltage | VDDA | | | | 4.6 | V | 1,2 |
| 3.3V Logic Supply Voltage | VDD | | | | 4.6 | V | 1,2 |
| Input Low Voltage | V _{IL} | | GND-0.5 | | | V | 1 |
| Input High Voltage | V _{IH} | Except for SMBus interface | | | V _{DD} +0.5V | V | 1 |
| Input High Voltage | V _{IHSMB} | SMBus clock and data pins | | | 5.5V | V | 1 |
| Storage Temperature | T _s | | -65 | | 150 | °C | 1 |
| Junction Temperature | T _j | | | | 125 | °C | 1 |
| Input ESD protection | ESD prot | Human Body Model | 2000 | | | V | 1 |

¹Guaranteed by design and characterization, not 100% tested in production.

²Operation under these conditions is neither implied nor guaranteed.

Electrical Characteristics - Input/Supply/Common Parameters

T_A = T_{COM}; Supply Voltage VDD = 3.3 V +/-5%

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|-------------------------------|-----------------------|---|-----------|-------|-----------------------|--------|-------|
| Ambient Operating Temperature | T _{COM} | Commercial range | 0 | | 70 | °C | 1 |
| Input High Voltage | V _{IH} | Single-ended inputs, except SMBus, low threshold and tri-level inputs | 2 | | V _{DD} + 0.3 | V | 1 |
| Input Low Voltage | V _{IL} | Single-ended inputs, except SMBus, low threshold and tri-level inputs | GND - 0.3 | | 0.8 | V | 1 |
| Input Current | I _{IN} | Single-ended inputs, V _{IN} = GND, V _{IN} = VDD | -5 | | 5 | uA | 1 |
| | I _{INP} | Single-ended inputs V _{IN} = 0 V; Inputs with internal pull-up resistors V _{IN} = VDD; Inputs with internal pull-down resistors | -200 | | 200 | uA | 1 |
| Input Frequency | F _{ibyp} | V _{DD} = 3.3 V, Bypass mode | 10 | | 166 | MHz | 2 |
| | F _{ipll} | V _{DD} = 3.3 V, 100MHz PLL mode | 90 | 100 | 110 | MHz | 2 |
| Pin Inductance | L _{pin} | | | | 7 | nH | 1 |
| Capacitance | C _{IN} | Logic Inputs, except DIF_IN | 1.5 | | 5 | pF | 1 |
| | C _{INDIF_IN} | DIF_IN differential clock inputs | 1.5 | | 2.7 | pF | 1,4 |
| | C _{OUT} | Output pin capacitance | | 2.5 | 6 | pF | 1 |
| Clk Stabilization | T _{STAB} | From V _{DD} Power-Up and after input clock stabilization or de-assertion of PD# to 1st clock | | 1.000 | 1.8 | ms | 1,2 |
| Input SS Modulation Frequency | f _{MODIN} | Allowable Frequency (Triangular Modulation) | 30 | | 33 | kHz | 1 |
| OE# Latency | t _{LATOE#} | DIF start after OE# assertion DIF stop after OE# deassertion | 4 | | 12 | cycles | 1,3 |
| Tdrive_PD# | t _{DRVPD} | DIF output enable after PD# de-assertion | | | 300 | us | 1,3 |
| Tfall | t _F | Fall time of control inputs | | | 5 | ns | 1,2 |
| Trise | t _R | Rise time of control inputs | | | 5 | ns | 1,2 |
| SMBus Input Low Voltage | V _{ILSMB} | | | | 0.8 | V | 1 |
| SMBus Input High Voltage | V _{IHSMB} | | 2.1 | | V _{DDSMB} | V | 1 |
| SMBus Output Low Voltage | V _{OLSMB} | @ I _{PULLUP} | | | 0.4 | V | 1 |
| SMBus Sink Current | I _{PULLUP} | @ V _{OL} | 4 | | | mA | 1 |
| Nominal Bus Voltage | V _{DDSMB} | 3V to 5V +/- 10% | 2.7 | | 5.5 | V | 1 |
| SCLK/SDATA Rise Time | t _{RSMB} | (Max VIL - 0.15) to (Min VIH + 0.15) | | | 1000 | ns | 1 |
| SCLK/SDATA Fall Time | t _{FSMB} | (Min VIH + 0.15) to (Max VIL - 0.15) | | | 300 | ns | 1 |
| SMBus Operating Frequency | f _{MAXSMB} | Maximum SMBus operating frequency | | | 100 | kHz | 1,5 |

¹Guaranteed by design and characterization, not 100% tested in production.

²Control input must be monotonic from 20% to 80% of input swing.

³Time from deassertion until outputs are >200 mV

⁴DIF_IN input

⁵The differential input clock must be running for the SMBus to be active

Electrical Characteristics - Clock Input ParametersT_A = T_{COM} or T_{IND}; Supply Voltage VDD = 3.3 V +/-5%

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|------------------------------------|--------------------|---|-----------------------|-----|------|-------|-------|
| Input High Voltage - DIF_IN | V _{IHDIF} | Differential inputs (single-ended measurement) | 600 | 800 | 1150 | mV | 1 |
| Input Low Voltage - DIF_IN | V _{ILDIF} | Differential inputs (single-ended measurement) | V _{SS} - 300 | 0 | 300 | mV | 1 |
| Input Common Mode Voltage - DIF_IN | V _{COM} | Common Mode Input Voltage | 300 | | 1000 | mV | 1 |
| Input Amplitude - DIF_IN | V _{SWING} | Peak to Peak value | 300 | | 1450 | mV | 1 |
| Input Slew Rate - DIF_IN | dv/dt | Measured differentially | 0.4 | | 8 | V/ns | 1,2 |
| Input Leakage Current | I _{IN} | V _{IN} = V _{DD} , V _{IN} = GND | -5 | | 5 | uA | 1 |
| Input Duty Cycle | d _{tin} | Measurement from differential waveform | 45 | | 55 | % | 1 |
| Input Jitter - Cycle to Cycle | J _{DIFIn} | Differential Measurement | 0 | | 125 | ps | 1 |

¹ Guaranteed by design and characterization, not 100% tested in production.² Slew rate measured through +/-75mV window centered around differential zero**Electrical Characteristics - DIF 0.7V Current Mode Differential Outputs**T_A = T_{COM}; Supply Voltage VDD = 3.3 V +/-5%

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|------------------------|------------|---|------|-----|------|-------|---------|
| Slew rate | Trf | Scope averaging on | 1 | 2 | 4 | V/ns | 1, 2, 3 |
| Slew rate matching | ΔTrf | Slew rate matching, Scope averaging on | | | 20 | % | 1, 2, 4 |
| Voltage High | VHigh | Statistical measurement on single-ended signal using oscilloscope math function. (Scope averaging on) | 660 | 789 | 850 | mV | 1 |
| Voltage Low | VLow | | -150 | 45 | 150 | | 1 |
| Max Voltage | Vmax | Measurement on single ended signal using absolute value. (Scope averaging off) | | 834 | 1150 | mV | 1 |
| Min Voltage | Vmin | | -300 | 17 | | | 1 |
| Vswing | Vswing | Scope averaging off | 300 | 744 | | mV | 1, 2 |
| Crossing Voltage (abs) | Vcross abs | Scope averaging off | 250 | 380 | 550 | mV | 1, 5 |
| Crossing Voltage (var) | ΔVcross | Scope averaging off | | 24 | 140 | mV | 1, 6 |

¹ Guaranteed by design and characterization, not 100% tested in production. I_{REF} = VDD/(3xR_R). For R_R = 475Ω (1%), I_{REF} = 2.32mA. I_{OH} = 6 x I_{REF} and V_{OH} = 0.7V @ Z_O=50Ω (100Ω differential impedance).² Measured from differential waveform³ Slew rate is measured through the Vswing voltage range centered around differential 0V. This results in a +/-150mV window around differential 0V.⁴ Matching applies to rising edge rate of Clock / falling edge rate of Clock#. It is measured in a +/-75mV window centered on the average cross point where Clock rising meets Clock# falling. The median cross point is used to calculate the voltage thresholds the oscilloscope uses for the edge rate calculations.⁵ Vcross is defined as voltage where Clock = Clock# measured on a component test board and only applies to the differential rising edge (i.e. Clock rising and Clock# falling).⁶ The total variation of all Vcross measurements in any particular system. Note that this is a subset of V_cross_min/max (V_cross absolute) allowed. The intent is to limit Vcross induced modulation by setting V_cross_delta to be smaller than V_cross absolute.**Electrical Characteristics - Current Consumption**T_A = T_{COM}; Supply Voltage VDD = 3.3 V +/-5%

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|--------------------------|-----------------------|---|-----|-----|-----|-------|-------|
| Operating Supply Current | I _{DD3,30P} | All outputs active @100MHz, C _L = Full load; | | 427 | 500 | mA | 1 |
| Powerdown Current | I _{DD3,3PDZ} | All differential pairs tri-stated | | 32 | 40 | mA | 1 |

¹ Guaranteed by design and characterization, not 100% tested in production.

Electrical Characteristics - Output Duty Cycle, Jitter, Skew and PLL Characteristics

TA = T_{COM}; Supply Voltage VDD = 3.3 V +/-5%

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|------------------------|-----------------------|---|------|------|------|-------|--------------------------|
| PLL Bandwidth | BW | -3dB point in High BW Mode | 2 | 3 | 4 | MHz | 1 |
| | | -3dB point in Low BW Mode | 0.7 | 1 | 1.4 | MHz | 1 |
| PLL Jitter Peaking | t _{JPEAK} | Peak Pass band Gain | | 1.4 | 2 | dB | 1 |
| Duty Cycle | t _{DC} | Measured differentially, PLL Mode | 45 | 49.5 | 55 | % | 1,2 |
| Duty Cycle Distortion | t _{DCD} | Measured differentially, Bypass Mode @100MHz | -2 | 1 | 2 | % | 1,2,5 |
| Skew, Input to Output | t _{pdBYP} | Bypass Mode, nominal value @ 25°C, 3.3V, V _T = 50% | 2500 | 3700 | 4500 | ps | 1,2,4 |
| | t _{pdPLL} | PLL Mode, nominal value @ 25°C, 3.3V, V _T = 50% | 100 | 300 | 500 | ps | 1,2,3 |
| DIF_IN, DIF [x:0] | Δt _{pd_BYP} | Input-to-Output Skew Variation in Bypass mode (over specified voltage / temperature operating ranges) | | 500 | 600 | ps | 1,2,4,6, 7,8,9, 13 |
| DIF_IN, DIF [x:0] | Δt _{pd_PLL} | Input-to-Output Skew Variation in PLL mode (over specified voltage / temperature operating ranges) | | 250 | 350 | ps | 1,2,3,6, 7,8,9, 13 |
| DIF[X:0] | t _{JPH} | Differential Phase Jitter (RMS Value) | | 2 | 10 | ps | 1,7,10 |
| DIF[X:0] | t _{SSTERROR} | Differential Spread Spectrum Tracking Error (peak to peak) | | 40 | 80 | ps | 1,7,12 |
| Skew, Output to Output | t _{sk3} | V _T = 50% | | 100 | 150 | ps | 1 |
| Jitter, Cycle to cycle | t _{jcyc-cyc} | PLL mode | | 40 | 50 | ps | 1,2 |
| | | Additive Jitter in Bypass Mode | | 25 | 50 | ps | 1,2 |

¹Guaranteed by design and characterization, not 100% tested in production. C_{LOAD} = 2pF

²Measured from differential cross-point to differential cross-point

³PLL mode Input-to-Output skew is measured at the first output edge following the corresponding input.

⁴All Bypass Mode Input-to-Output specs refer to the timing between an input edge and the specific output edge created by it.

⁵Duty cycle distortion is the difference in duty cycle between the output and the input clock when the device is operated in bypass mode.

⁶V_T = 50% of V_{out}

⁷This parameter is deterministic for a given device

⁸Measured with scope averaging on to find mean value.

⁹Long-term variation from nominal of input-to-output skew over temperature and voltage for a single device.

¹⁰This parameter is measured at the outputs of two separate 9DB1933 devices driven by a single main clock. The 9DB1933's must be set to high bandwidth. Differential phase jitter is the accumulation of the phase jitter not shared by the outputs (eg. not including the

¹¹t is the period of the input clock

¹²Differential spread spectrum tracking error is the difference in spread spectrum tracking between two 9DB1933 devices. This parameter is measured at the outputs of two separate 9DB1933 devices driven by a single main clock in Spread Spectrum mode. The 9DB1933's must be set to high bandwidth. The spread spectrum characteristics are: maximum of 0.5%, 30-33KHz modulation frequency, linear

¹³This parameter is an absolute value. It is not a double-sided figure.

Electrical Characteristics - PCIe Phase Jitter ParametersTA = T_{COM}; Supply Voltage VDD = 3.3 V +/-5%

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | Notes |
|---------------------------------------|------------------------|--|-----|------|-----|----------|-------|
| Phase Jitter, PLL Mode | t _{jphPCIeG1} | PCIe Gen 1 | | 44 | 86 | ps (p-p) | 1,2,3 |
| | t _{jphPCIeG2} | PCIe Gen 2 Lo Band 10kHz < f < 1.5MHz | | 1.4 | 3 | ps (rms) | 1,2 |
| | | PCIe Gen 2 High Band 1.5MHz < f < Nyquist (50MHz) | | 2.5 | 3.1 | ps (rms) | 1,2 |
| | t _{jphPCIeG3} | PCIe Gen 3 (PLL BW of 2-4MHz, CDR = 10MHz) | | 0.6 | 1 | ps (rms) | 1,2,4 |
| Additive Phase Jitter, Bypass Mode | t _{jphPCIeG1} | PCIe Gen 1 | | 3 | 5 | ps (p-p) | 1,2,3 |
| | t _{jphPCIeG2} | PCIe Gen 2 Lo Band 10kHz < f < 1.5MHz | | 0.02 | 0.1 | ps (rms) | 1,2 |
| | | PCIe Gen 2 High Band 1.5MHz < f < Nyquist (50MHz) | | 0.2 | 0.3 | ps (rms) | 1,2 |
| | t _{jphPCIeG3} | PCIe Gen 3 (PLL BW of 2-4MHz, CDR = 10MHz) | | 0.04 | 0.1 | ps (rms) | 1,2,4 |

¹ Applies to all outputs.² See <http://www.pcisig.com> for complete specs³ Sample size of at least 100K cycles. This figures extrapolates to 108ps pk-pk @ 1M cycles for a BER of 1-12.⁴ Subject to final radification by PCI SIG.

Clock Periods Differential Outputs with Spread Spectrum Enabled

| Measurement Window | | 1 Clock | 1us | 0.1s | 0.1s | 0.1s | 1us | 1 Clock | Units | Notes |
|--------------------|---------|-------------------------|-------------------------|-------------------------|----------|-------------------|--------------------|----------|-------|-------|
| Symbol | | Lg- | -SSC | -ppm error | 0ppm | + ppm error | +SSC | Lg+ | | |
| Definition | | Absolute Period | Short-term Average | Long-Term Average | Period | Long-Term Average | Short-term Average | Period | | |
| | | Minimum Absolute Period | Minimum Absolute Period | Minimum Absolute Period | Nominal | Maximum | Maximum | Maximum | | |
| DIF | DIF 100 | 9.87400 | 9.99900 | 9.99900 | 10.00000 | 10.00100 | 10.05130 | 10.17630 | ns | 1,2,3 |

Clock Periods Differential Outputs with Spread Spectrum Disabled

| Measurement Window | | 1 Clock | 1us | 0.1s | 0.1s | 0.1s | 1us | 1 Clock | Units | Notes |
|--------------------|---------|-------------------------|-------------------------|-------------------------|----------|-------------------|--------------------|----------|-------|-------|
| Symbol | | Lg- | -SSC | -ppm error | 0ppm | + ppm error | +SSC | Lg+ | | |
| Definition | | Absolute Period | Short-term Average | Long-Term Average | Period | Long-Term Average | Short-term Average | Period | | |
| | | Minimum Absolute Period | Minimum Absolute Period | Minimum Absolute Period | Nominal | Maximum | Maximum | Maximum | | |
| DIF | DIF 100 | 9.87400 | | 9.99900 | 10.00000 | 10.00100 | | 10.17630 | ns | 1,2,3 |

¹Guaranteed by design and characterization, not 100% tested in production.

²All Long Term Accuracy specifications are guaranteed with the assumption that the input clock complies with CK410B+/CK420BQ accuracy requirements. The 9DB1933 itself does not contribute to ppm error.

³ Driven by SRC output of main clock, PLL or Bypass mode

| DIF Reference Clock | | | |
|---|--------------------|------|--------|
| Common Recommendations for Differential Routing | Dimension or Value | Unit | Figure |
| L1 length, route as non-coupled 50ohm trace | 0.5 max | inch | 1 |
| L2 length, route as non-coupled 50ohm trace | 0.2 max | inch | 1 |
| L3 length, route as non-coupled 50ohm trace | 0.2 max | inch | 1 |
| R_s | 33 | ohm | 1 |
| R_t | 49.9 | ohm | 1 |

| Down Device Differential Routing | | | |
|--|---------------------|------|---|
| L4 length, route as coupled microstrip 100ohm differential trace | 2 min to 16 max | inch | 1 |
| L4 length, route as coupled stripline 100ohm differential trace | 1.8 min to 14.4 max | inch | 1 |

| Differential Routing to PCI Express Connector | | | |
|--|-----------------------|------|---|
| L4 length, route as coupled microstrip 100ohm differential trace | 0.25 to 14 max | inch | 2 |
| L4 length, route as coupled stripline 100ohm differential trace | 0.225 min to 12.6 max | inch | 2 |

Figure 1: Down Device Routing

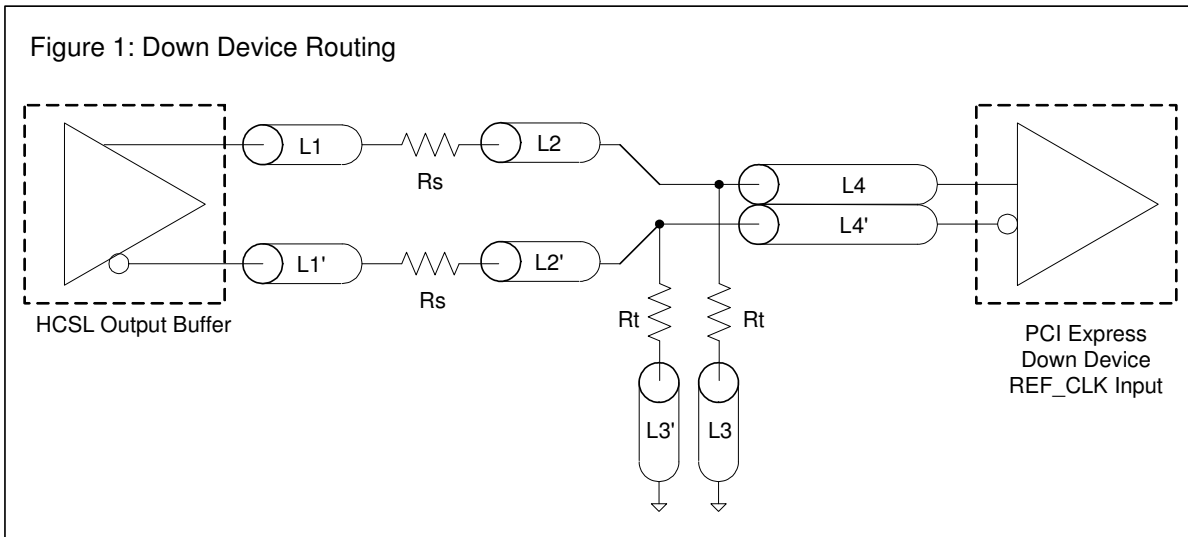
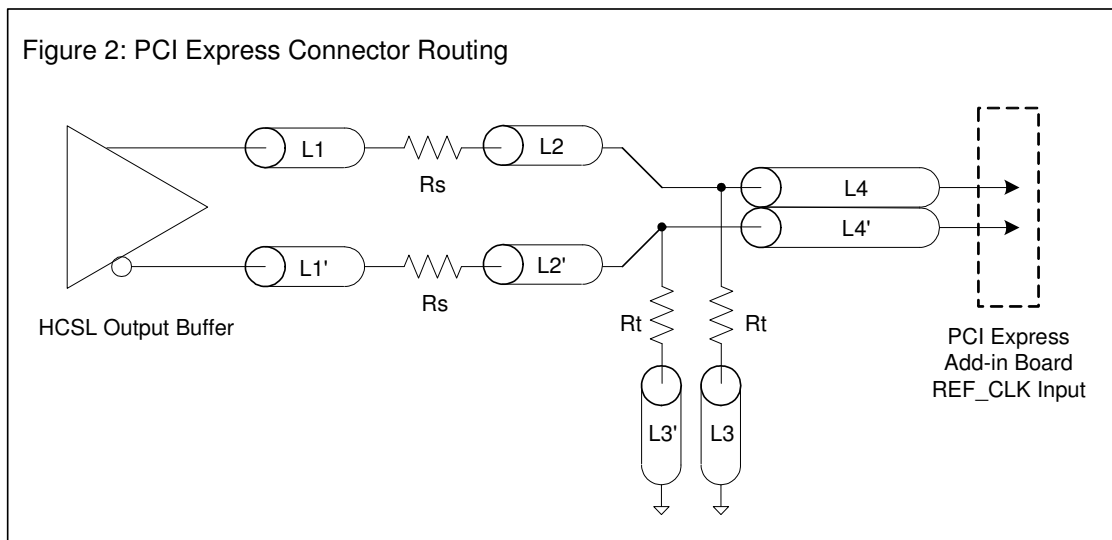


Figure 2: PCI Express Connector Routing

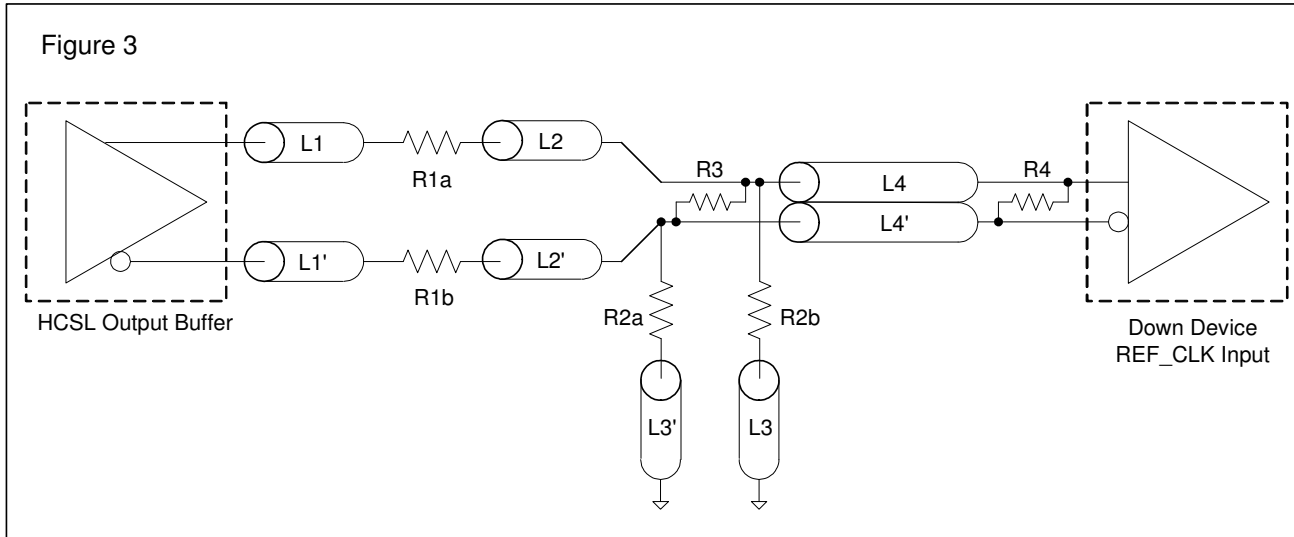


Alternative Termination for LVDS and other Common Differential Signals (figure 3)

| Vdiff | Vp-p | Vcm | R1 | R2 | R3 | R4 | Note |
|-------|-------|------|----|------|------|-----|--------------------------------|
| 0.45v | 0.22v | 1.08 | 33 | 150 | 100 | 100 | |
| 0.58 | 0.28 | 0.6 | 33 | 78.7 | 137 | 100 | |
| 0.80 | 0.40 | 0.6 | 33 | 78.7 | none | 100 | ICS874003i-02 input compatible |
| 0.60 | 0.3 | 1.2 | 33 | 174 | 140 | 100 | Standard LVDS |

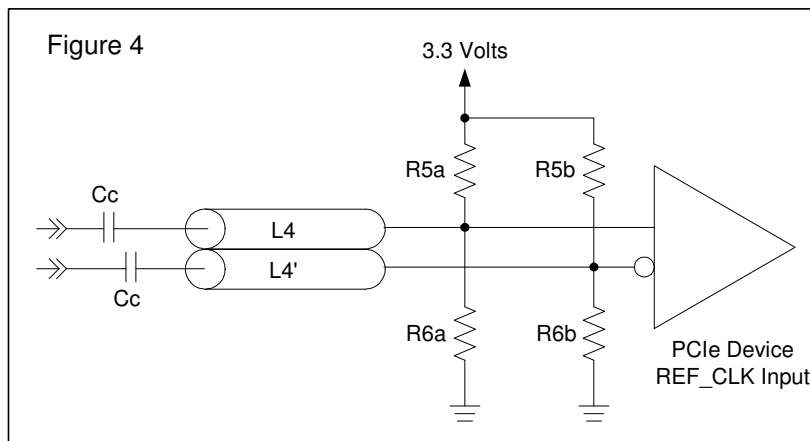
R1a = R1b = R1

R2a = R2b = R2



Cable Connected AC Coupled Application (figure 4)

| Component | Value | Note |
|-----------|-------------|------|
| R5a, R5b | 8.2K 5% | |
| R6a, R6b | 1K 5% | |
| Cc | 0.1 μ F | |
| Vcm | 0.350 volts | |



General SMBus serial interface information for the 9DB1933

How to Write:

- Controller (host) sends a start bit.
- Controller (host) sends the write address $DC_{(h)}$
- ICS clock will **acknowledge**
- Controller (host) sends the beginning byte location = N
- ICS clock will **acknowledge**
- Controller (host) sends the data byte count = X
- ICS clock will **acknowledge**
- Controller (host) starts sending **Byte N through Byte N + X - 1**
- ICS clock will **acknowledge** each byte **one at a time**
- Controller (host) sends a Stop bit

How to Read:

- Controller (host) will send start bit.
- Controller (host) sends the write address $DC_{(h)}$
- ICS clock will **acknowledge**
- Controller (host) sends the beginning byte location = N
- ICS clock will **acknowledge**
- Controller (host) will send a separate start bit.
- Controller (host) sends the read address $DD_{(h)}$
- ICS clock will **acknowledge**
- ICS clock will send the data byte count = X
- ICS clock sends **Byte N + X - 1**
- ICS clock sends **Byte 0 through byte X (if $X_{(h)}$ was written to byte 8).**
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

| Index Block Write Operation | | | |
|-----------------------------|-----------|----------------------|-----|
| Controller (Host) | | ICS (Slave/Receiver) | |
| T | starT bit | | |
| Slave Address $DC_{(h)}$ | | | |
| WR | WRite | | |
| | | ACK | |
| Beginning Byte = N | | | |
| | | ACK | |
| Data Byte Count = X | | | |
| | | ACK | |
| Beginning Byte N | | X Byte | |
| | | | ACK |
| ◊ | | | ◊ |
| ◊ | | | ◊ |
| ◊ | | | ◊ |
| Byte N + X - 1 | | | |
| | | ACK | |
| P | stoP bit | | |

| Index Block Read Operation | | | |
|----------------------------|-----------------|----------------------|------------------|
| Controller (Host) | | ICS (Slave/Receiver) | |
| T | starT bit | | |
| Slave Address $DC_{(h)}$ | | | |
| WR | WRite | | |
| | | ACK | |
| Beginning Byte = N | | | |
| | | ACK | |
| RT | Repeat starT | | |
| Slave Address $DD_{(h)}$ | | | |
| RD | ReaD | | |
| | | ACK | |
| | | Data Byte Count = X | |
| ACK | | | |
| ACK | | X Byte | |
| | | | Beginning Byte N |
| ◊ | | | ◊ |
| ◊ | | | ◊ |
| ◊ | | | ◊ |
| | | Byte N + X - 1 | |
| N | Not acknowledge | | |
| P | stoP bit | | |

Note: Addresses show assumes pin 29 is low.

SMBusTable: Reserved Register

| Byte 0 | Pin # | Name | Control Function | Type | 0 | 1 | Default |
|--------|-------|------|------------------|------|---|---|---------|
| Bit 7 | - | | Reserved | R | | | 1 |
| Bit 6 | - | | Reserved | R | | | 1 |
| Bit 5 | - | | Reserved | R | | | 1 |
| Bit 4 | - | | Reserved | R | | | 1 |
| Bit 3 | - | | Reserved | R | | | 1 |
| Bit 2 | - | | Reserved | R | | | 0 |
| Bit 1 | - | | Reserved | R | | | 1 |
| Bit 0 | - | | Reserved | R | | | 1 |

SMBusTable: Output Control Register

| Byte 1 | Pin # | Name | Control Function | Type | 0 | 1 | Default |
|--------|-------|-------|------------------|------|------|--------|---------|
| Bit 7 | | DIF_7 | Output Control | RW | Hi-Z | Enable | 1 |
| Bit 6 | | DIF_6 | Output Control | RW | Hi-Z | Enable | 1 |
| Bit 5 | | DIF_5 | Output Control | RW | Hi-Z | Enable | 1 |
| Bit 4 | | DIF_4 | Output Control | RW | Hi-Z | Enable | 1 |
| Bit 3 | | DIF_3 | Output Control | RW | Hi-Z | Enable | 1 |
| Bit 2 | | DIF_2 | Output Control | RW | Hi-Z | Enable | 1 |
| Bit 1 | | DIF_1 | Output Control | RW | Hi-Z | Enable | 1 |
| Bit 0 | | DIF_0 | Output Control | RW | Hi-Z | Enable | 1 |

SMBusTable: Output and PLL BW Control Register

| Byte 2 | Pin # | Name | Control Function | Type | 0 | 1 | Default |
|--------|----------|--------|-------------------------|------|---------|--------|---------|
| Bit 7 | see note | | PLL_BW# adjust | RW | High BW | Low BW | 1 |
| Bit 6 | see note | | BYPASS# test mode / PLL | RW | Bypass | PLL | 1 |
| Bit 5 | | DIF_13 | Output Control | RW | Hi-Z | Enable | 1 |
| Bit 4 | | DIF_12 | Output Control | RW | Hi-Z | Enable | 1 |
| Bit 3 | | DIF_11 | Output Control | RW | Hi-Z | Enable | 1 |
| Bit 2 | | DIF_10 | Output Control | RW | Hi-Z | Enable | 1 |
| Bit 1 | | DIF_9 | Output Control | RW | Hi-Z | Enable | 1 |
| Bit 0 | | DIF_8 | Output Control | RW | Hi-Z | Enable | 1 |

Note: Bit 7 is wired OR to the HIGH_BW# input, any 0 selects High BW

Note: Bit 6 is wired OR to the SMB_A2_PLLBYP# input, any 0 selects Fanout Bypass mode

SMBusTable: Output Enable Readback Register

| Byte 3 | Pin # | Name | Control Function | Type | 0 | 1 | Default |
|--------|-------|------|------------------------------|------|----------|---|---------|
| Bit 7 | | | Readback - OE9# Input | R | Readback | | X |
| Bit 6 | | | Readback - OE8# Input | R | Readback | | X |
| Bit 5 | | | Readback - OE7# Input | R | Readback | | X |
| Bit 4 | | | Readback - OE6# Input | R | Readback | | X |
| Bit 3 | | | Readback - OE5# Input | R | Readback | | X |
| Bit 2 | | | Readback - OE_01234# Input | R | Readback | | X |
| Bit 1 | 8 | | Readback - HIGH_BW# In | R | Readback | | X |
| Bit 0 | 72 | | Readback - SMB_A2_PLLBYP# In | R | Readback | | X |

SMBusTable: Output Enable Readback Register

| Byte 4 | Pin # | Name | Control Function | Type | 0 | 1 | Default | |
|--------|-------|---------------------------|------------------|------|----------|---|---------|---|
| Bit 7 | 69 | Readback - OE17_18# Input | | R | Readback | | X | |
| Bit 6 | 60 | Readback - OE15_16# Input | | R | Readback | | X | |
| Bit 5 | | Reserved | | | | | | 0 |
| Bit 4 | 54 | Readback - OE14# Input | | R | Readback | | X | |
| Bit 3 | 51 | Readback - OE13# Input | | R | Readback | | X | |
| Bit 2 | 48 | Readback - OE12# Input | | R | Readback | | X | |
| Bit 1 | 43 | Readback - OE11# Input | | R | Readback | | X | |
| Bit 0 | 40 | Readback - OE10# Input | | R | Readback | | X | |

SMBusTable: Vendor & Revision ID Register

| Byte 5 | Pin # | Name | Control Function | Type | 0 | 1 | Default |
|--------|-------|------|------------------|------|---|---|---------|
| Bit 7 | - | RID3 | REVISION ID | R | - | - | 0 |
| Bit 6 | - | RID2 | | R | - | - | 0 |
| Bit 5 | - | RID1 | | R | - | - | 0 |
| Bit 4 | - | RID0 | | R | - | - | 1 |
| Bit 3 | - | VID3 | VENDOR ID | R | - | - | 0 |
| Bit 2 | - | VID2 | | R | - | - | 0 |
| Bit 1 | - | VID1 | | R | - | - | 0 |
| Bit 0 | - | VID0 | | R | - | - | 1 |

SMBusTable: DEVICE ID (194 Decimal or C2 Hex)

| Byte 6 | Pin # | Name | Control Function | Type | 0 | 1 | Default |
|--------|-------|-------------------|------------------|------|----------|---|---------|
| Bit 7 | - | Device ID 7 (MSB) | | RW | Reserved | | 1 |
| Bit 6 | - | Device ID 6 | | RW | Reserved | | 1 |
| Bit 5 | - | Device ID 5 | | RW | Reserved | | 0 |
| Bit 4 | - | Device ID 4 | | RW | Reserved | | 0 |
| Bit 3 | - | Device ID 3 | | RW | Reserved | | 0 |
| Bit 2 | - | Device ID 2 | | RW | Reserved | | 0 |
| Bit 1 | - | Device ID 1 | | RW | Reserved | | 1 |
| Bit 0 | - | Device ID 0 | | RW | Reserved | | 0 |

SMBusTable: Byte Count Register

| Byte 7 | Pin # | Name | Control Function | Type | 0 | 1 | Default |
|--------|-------|------|---|------|---|---|---------|
| Bit 7 | - | BC7 | Writing to this register configures how many bytes will be read back. | RW | - | - | 0 |
| Bit 6 | - | BC6 | | RW | - | - | 0 |
| Bit 5 | - | BC5 | | RW | - | - | 0 |
| Bit 4 | - | BC4 | | RW | - | - | 0 |
| Bit 3 | - | BC3 | | RW | - | - | 0 |
| Bit 2 | - | BC2 | | RW | - | - | 1 |
| Bit 1 | - | BC1 | | RW | - | - | 1 |
| Bit 0 | - | BC0 | | RW | - | - | 1 |

SMBusTable: Output Control Register

| Byte 8 | Pin # | Name | Control Function | Type | 0 | 1 | Default |
|--------|-------|--------|------------------|------|------|--------|---------|
| Bit 7 | | | RESERVED | | | | 1 |
| Bit 6 | | | RESERVED | | | | X |
| Bit 5 | | | RESERVED | | | | X |
| Bit 4 | | DIF_18 | Output Control | RW | Hi-Z | Enable | 1 |
| Bit 3 | | DIF_17 | Output Control | RW | Hi-Z | Enable | 1 |
| Bit 2 | | DIF_16 | Output Control | RW | Hi-Z | Enable | 1 |
| Bit 1 | | DIF_15 | Output Control | RW | Hi-Z | Enable | 1 |
| Bit 0 | | DIF_14 | Output Control | RW | Hi-Z | Enable | 1 |

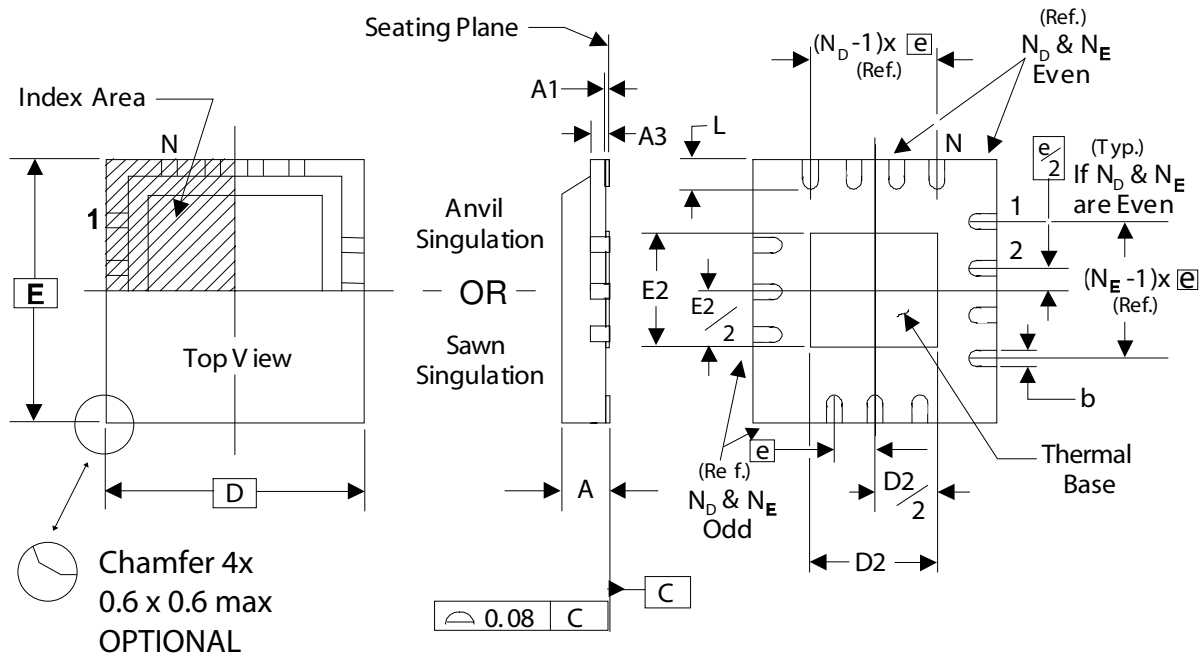
SMBusTable: Reserved Register

| Byte 9 | Pin # | Name | Control Function | Type | 0 | 1 | Default |
|--------|-------|------|------------------|------|---|---|---------|
| Bit 7 | | | RESERVED | | | | 0 |
| Bit 6 | | | RESERVED | | | | 0 |
| Bit 5 | | | RESERVED | | | | 0 |
| Bit 4 | | | RESERVED | | | | 0 |
| Bit 3 | | | RESERVED | | | | 0 |
| Bit 2 | | | RESERVED | | | | 1 |
| Bit 1 | | | RESERVED | | | | 0 |
| Bit 0 | | | RESERVED | | | | 1 |

SMBus Address Mapping

| SMBus Address (Hex) | Main Clock (CKxxx) | 9DB233 | 9DB433 | 9DB633 | 9DB833 | 9DB1233 | 9DB1933 |
|---------------------|--------------------|--------|--------|--------|--------|---------|---------|
| D0 | | | | | | | ✓ |
| D2 | ✓ | | | | | | ✓ |
| D4 | | ✓ | | ✓ | | ✓ | ✓ |
| D6 | | | | | | ✓ | ✓ |
| D8 | | | ✓ | | ✓ | | ✓ |
| DA | | | ✓ | | ✓ | | ✓ |
| DC | | | ✓ | | ✓ | ✓ | ✓ |
| DE | | | | | | | ✓ |

Note: Indicates Bypass Mode. PLL is OFF.



THERMALLY ENHANCED, VERY THIN, FINE PITCH
QUAD FLAT / NO LEAD PLASTIC PACKAGE

DIMENSIONS

| SYMBOL | 72L |
|--------|-----|
| N | 72 |
| N_D | 18 |
| N_E | 18 |

DIMENSIONS (mm)

| SYMBOL | MIN. | MAX. |
|----------------|----------------|------|
| A | 0.8 | 1.0 |
| A1 | 0 | 0.05 |
| A3 | 0.25 Reference | |
| b | 0.18 | 0.3 |
| e | 0.50 BASIC | |
| D x E BASIC | 10.00 x 10.00 | |
| D2 MIN. / MAX. | 5.75 | 6.15 |
| E2 MIN. / MAX. | 5.75 | 6.15 |
| L MIN. / MAX. | 0.3 | 0.5 |

Ordering Information

| Part / Order Number | Shipping Packaging | Package | Temperature |
|---------------------|--------------------|------------|-------------|
| 9DB1933AKLF | Tubes | 72-pin MLF | 0 to +70°C |
| 9DB1933AKLFT | Tape and Reel | 72-pin MLF | 0 to +70°C |

“LF” after the package code denotes the Pb-Free configuration, RoHS compliant.
“A” is the device revision designator (will not correlate with the datasheet revision).

Revision History

| Rev. | Issue Date | Who | Description | Page # |
|------|------------|-----|--|-----------|
| 0.1 | 7/7/2010 | RDW | Initial release | - |
| A | 7/12/2010 | RDW | 1. Updated 'PWD' to 'Default' in SMBus column headings 2. Updated electrical tables with char data 3. Added SMBusAddressing Table to page 15 | 5-8,13-15 |
| | | | | |
| | | | | |
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